

MULTILAYER CERAMIC CHIP CAPACITORS



Surface Mount Device

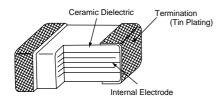
◆FEATURES

- 1. Large capacitance by small size.
- 2. Excellent noise absorption.
- 3. High permissible ripple current capability.
- 4. Lead free dielectric and terminations.
- 5. Tin plate terminations.

APPLICATIONS

- 1. Smoothing circuit of DC-DC converters.
- 2. On-board power supplies.
- 3. Voltage regulators for computers.
- 3. Noise suppressor for various kinds of equipments.
- 4. High reliability equipments.

◆CONSTRUCTION



◆RATINGS

Category Temperature Range	-55 to +125℃
2. Rated Voltage Range	25, 50, 100, 250Vdc
3. Rated Capacitance Range	0.033 to 33µF
4. Rated Capacitance Tolerance	K (±10%), M (±20%)
5. Temperature Characteristics	X5R, X7R
6. Rated Ripple Current	See No.5 on the following table

♦SPECIFICATIONS

No.	Items	Specification	Test Condition			
1	Withstand Voltage	No abnormality.	250% of rated voltage shall be applied for 5 seconds.			
2	Insulation Resistance	100/CR(MΩ) or 4000(MΩ) whichever is less.	_	Rated voltage shall be applied for 60±5 seconds at temperature 25±2℃.		
3	Rated Capacitance	Within specified tolerance.		Cr≦10µF	Cr>10µF	
			Temperature	25±2℃		
4	Dissipation Factor	5.0% maximum.	Frequency	1±0.1kHz	120±12Hz	
			Voltage	1±0.2Vrms	0.5±0.2Vrms	
5	Rated Ripple Current	Size code 31 32 43 55 Arms 0.3 0.5 1.0 2.0		Hz∼1MHz (sine curve) ble voltage Vp shall be less than rated voltage.		





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♦SPECIFICATIONS

No.	ltems	Specification	Test Condition		
6	Adhesion	No visible damage.	Substrate 5N (0.51kgf) for 10±1 seconds Capacitor		
7	Bend strength of the face plating	Appearance : No visible damage. ΔC/C : ±15%	The substrate shall be bend by 1mm at a rate of 1mm/s for 5 seconds. Press Press ber Substrate Substrate 1.0mm Support		
8	Solderability	Min. 75% of surface of the termination shall be covered with new solder	Solder Temperature : 235±5°C Dipping Time : 2±0.5 sec. Solder : Eutectic solder containning Ag2.5 to 3wt%		
9	Resistance to Soldering Heat	Appearance: No visible damage. ΔC/C: ±15% D.F.: To meet the initial specification. I.R.: To meet the initial specification. Withstand voltage: No abnormality.	Solder Temperature : 260±5℃ Dipping Time : 2±0.5 seconds Solder : Eutectic solder containning Ag2.5 to 3wt%		
10	Temperature Cycle Humidity Load Life	Appearance : No visible damage. $\Delta C/C$: $\pm 15\%$ D.F. : To meet the initial specification. I.R. : To meet the initial specification. Withstand voltage : No abnormality. Appearance : No abnormality. $\Delta C/C$: $\pm 15\%$	Step Temperature (°C) (min.) 1 Min. Category temperature ±3 30±3 2 Room temperature 3 max. 3 Max. Category temperature ±2 30±3 4 Room temperature 3 max. For 5 cycles for above temperature cycle. Temperature : 40±2°C Humidity : 90 to 95%RH		
		D.F. : 10% maximum I.R. : 25/C _R (MΩ) or 1000(MΩ) whichever is less. Withstand voltage : No abnormality. Voltage : Rated voltage Time : 500±24/hours			
12	Endurance	Appearance : No abnormality. $\Delta C/C$: $\pm 15\%$ D.F. : 10% maximum I.R. : $50/C_R(M\Omega)$ or $1000(M\Omega)$ whichever is less. Withstand voltage : No abnormality.	Temperature: $85\pm2^{\circ}$ C Voltage: 200% of rated voltage. Time: $1000\pm^{48}_{0}$ hours Temperature: $125\pm3^{\circ}$ C Voltage: Rated voltage Time: $1000\pm^{48}_{0}$ hours		

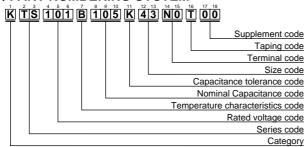
*CR : Rated Capacitance(µF)



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◆PART NUMBERING SYSTEM



♦NTS SERIES STANDARD RATINGS

David Normalis and	Rated voltage Rated Ca	Rated Capacitance		Dimensi	ons(mm)		Previous Part Number (Just for your reference)
Part Number	(Vdc)	(μ F)	L	w	Tmax.	а	
KTS250C105M31N0T00	25	1.0	3.2±0.2			0.5±0.3	NTS30X5R1E105MT
KTS250C155M31N0T00		1.5		1.6±0.2	1.8		NTS30X5R1E155MT
KTS250C225M31N0T00		2.2					NTS30X5R1E225MT
KTS250C335M32N0T00		3.3	3.2±0.4	2.5±0.3	2.6	0.6±0.3	NTS40X5R1E335MT
KTS250C475M32N0T00		4.7					NTS40X5R1E475MT
KTS250C685M32N0T00		6.8					NTS40X5R1E685MT
KTS250C106M43N0T00		10	4.5±0.4	3.2±0.4	2.8	0.6±0.3	NTS50X5R1E106MT
KTS250C156M43N0T00		15			2.0		NTS50X5R1E156MT
KTS250C226M55N0T00		22	5.7±0.4	5.0±0.4	2.8	0.8±0.5	NTS60X5R1E226MT
KTS250C336M55N0T00		33	3.7±0.4	5.0±0.4	2.0		NTS60X5R1E336MT
KTS500C334M31N0T00		0.33					NTS30X5R1H334MT
KTS500C474M31N0T00		0.47	3.2 ± 0.2	1.6±0.2	1.8	0.5±0.3	NTS30X5R1H474MT
KTS500C684M31N0T00		0.68					NTS30X5R1H684MT
KTS500C105M32N0T00		1.0					NTS40X5R1H105MT
KTS500C155M32N0T00	50	1.5	3.2±0.4	2.5±0.3	2.6	0.6±0.3	NTS40X5R1H155MT
KTS500C225M32N0T00]	2.2					NTS40X5R1H225MT
KTS500C335M43N0T00		3.3	4.5±0.4	3.2±0.4	2.6	0.6±0.3	NTS50X5R1H335MT
KTS500C475M43N0T00		4.7		3.Z±0.4	2.8	0.0±0.0	NTS50X5R1H475MT
KTS500C685M55N0T00		6.8	5.7±0.4	5.0±0.4	2.6	- 0.8±0.5	NTS60X5R1H685MT
KTS500C106M55N0T00		10		5.0±0.4	2.8		NTS60X5R1H106MT
KTS101B104K31N0T00		0.1	3.2±0.2		1.8	0.5±0.3	NTS30X7R2A104KT
KTS101B154K31N0T00		0.15		1.6±0.2			NTS30X7R2A154KT
KTS101B224K31N0T00		0.22					NTS30X7R2A224KT
KTS101B334K31N0T00		0.33					NTS30X7R2A334KT
KTS101B474K32N0T00	100	0.47	3.2±0.4	2.5±0.3	2.6	0.6±0.3	NTS40X7R2A474KT
KTS101B684K32N0T00		0.68					NTS40X7R2A684KT
KTS101B105K32N0T00		1.0					NTS40X7R2A105KT
KTS101B155K43N0T00		1.5	4.5±0.4 5.7±0.4	3.2±0.4 5.0±0.4	2.8	0.6±0.3 0.8±0.5	NTS50X7R2A155KT
KTS101B225K43N0T00		2.2					NTS50X7R2A225KT
KTS101B335K55N0T00	250	3.3					NTS60X7R2A335KT
KTS101B475K55N0T00		4.7					NTS60X7R2A475KT
KTS251B333K31N0T00		0.033		1.6±0.2	1.8	0.5±0.3	NTS30X7R2E333KT
KTS251B473K31N0T00		0.047	3.2±0.2				NTS30X7R2E473KT
KTS251B683K31N0T00		0.068					NTS30X7R2E683KT
KTS251B104K32N0T00		0.1	3.2±0.4	2.5±0.3	2.6	0.6±0.3	NTS40X7R2E104KT
KTS251B154K32N0T00		0.15					NTS40X7R2E154KT
KTS251B224K32N0T00		0.22					NTS40X7R2E224KT
KTS251B334K43N0T00		0.33	4.5±0.4	3.2±0.4	2.6	0.6±0.3	NTS50X7R2E334KT
KTS251B474K43N0T00		0.47			2.8		NTS50X7R2E474KT
KTS251B684K55N0T00		0.68	5.7±0.4	5.0±0.4	2.6	0.8±0.5	NTS60X7R2E684KT
KTS251B105K55N0T00		1.0			2.8		NTS60X7R2E105KT